

12-19-2003

Form PTO-1595

RE



102627616

T

U.S. Department of Commerce

ERev. 6-93)

Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies): Chin-Kai SUN 9.11-03 Additional name(s) of conveying parties attached? <input type="checkbox"/> YES <input checked="" type="checkbox"/> NO	2. Name and address of receiving parties: Name: <u>BENQ Corporation</u> Internal Address: Street Address: <u>No. 157, Shan-Ying Road, Kweishan, Taoyuan, Taiwan, R.O.C.</u> City: _____ State: _____ Zip: _____ Country: _____ Additional name(s) & address(es) attached? <input type="checkbox"/> YES <input checked="" type="checkbox"/> NO
3. Nature of conveyance: <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name <input type="checkbox"/> Other _____ Execution Date: <u>May 26, 2003</u>	

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No(s).: 10/436,367 B. Patent No(s).: _____Additional numbers attached? ☐ YES ☒ NO

5. Name and address of party to whom correspondence concerning document should be mailed: Richard P. Berg Name: <u>LADAS & PARRY</u> Internal Address: _____ Street Address: <u>5670 Wilshire Boulevard, #2100</u> City: <u>Los Angeles</u> State: <u>CA</u> Zip: <u>90036</u>	6. Total number of application and patents involved: <input type="checkbox"/> 1 7. Total fee 937 CFR 3.41).....\$ <u>40.00</u> <input checked="" type="checkbox"/> Enclosed Any additional fees which may be required are <input checked="" type="checkbox"/> Authorized to be charged to deposit account No. <u>12-0415</u> 8. Deposit account number: _____ (Attach duplicate copy of this page if paying by deposit account)
---	---

12/18/2003 LNUELLER 00000157 10436367

01 FC 8021

40.00 DP

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Ross A. Schmitt
 Name of Person Signing
 Reg. No. 42,529

Ross A. Schmitt
 Signature

September 8, 2003
 Date

(SEE PAGE 2 FOR CERTIFICATE OF MAILING)

Total number of pages including cover sheet, attachments, and document: [3] plus \$40 check

Mail documents to be recorded with required cover sheet information to:

 Mail Stop Assignment Recordation Services
 Director of US Patent & Trademark Office
 P.O. Box 1450
 Alexandria, VA 22313-1450

Public burden reporting for this sample cover sheet is estimated to average about 30 minutes per document to be recorded, including time for reviewing the document and gathering the data needed, and completing and reviewing the sample cover sheet. Send comments regarding this burden estimate to the U.S. Patent and Trademark Office, Office of Information Systems, PK2-1000C, Washington, D.C. 20231, and to the Office of Management and Budget, Paperwork Reduction Project (0651-0011), Washington, D.C., 20503.

Published by THE BUREAU OF NATIONAL AFFAIRS, INC., Washington, D.C. 20037)

 PATENT
 REEL: 014802 FRAME: 0909

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

ELECTRICAL CONNECTOR FOR INTERCONNECTING A CIRCUIT BOARD AND A VIBRATION MODULE IN AN ELECTRONIC APPARATUS

for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on May 13, 2003, (Serial No. _____); and

WHEREAS, **Benq Corporation**, a corporation of **Taiwan**, whose post office address is **No. 157, Shan-Ying Rd., Kuei-Shan Hsiang, Tao-Yuan Hsien, Taiwan**, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. _____, filed May 13, 2003) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

Full Name of Sole or First Assignor Chin-Kai Sun	Assignor's Signature <i>Chin-Kai Sun</i>	Date <i>5/13/03</i>
Address No. 32-2, Lane 269, Ssu-Wei Rd., Pan-Chiao City, Taipei Hsien, Taiwan		Citizenship Taiwan
Full Name of Second Assignor	Assignor's Signature	Date
Address		Citizenship
Names of additional inventors attached <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No		